

## 20V P-Ch Power MOSFET

### Feature

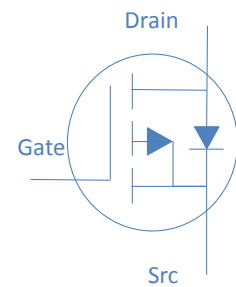
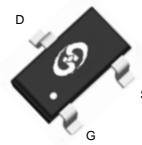
- ◇ High Speed Power Switching, Logic Level
- ◇ Enhanced Avalanche Ruggedness
- ◇ Lead Free, Halogen Free

$V_{DS}$		-20	V
$R_{DS(on),typ}$	$V_{GS}=4.5V$	83	mΩ
$R_{DS(on),typ}$	$V_{GS}=2.5V$	110	mΩ
$I_D$ (Silicon Limited)		-3	A

### Application

- ◇ Load Switches
- ◇ Hard Switching and High Speed Circuit
- ◇ BLDC Motor

SOT-23



Part Number	Package	Marking
HTJ1K0P02	SOT-23	21

### Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	$I_D$	$T_A=25^\circ\text{C}$	-3	A
		$T_A=70^\circ\text{C}$	-2.4	
Drain to Source Voltage	$V_{DS}$	-	-20	V
Gate to Source Voltage	$V_{GS}$	-	$\pm 12$	V
Pulsed Drain Current	$I_{DM}$	-	-12	A
Power Dissipation	$P_D$	$T_A=25^\circ\text{C}$	1.25	W
Operating and Storage Temperature	$T_J, T_{stg}$	-	-55 to 150	$^\circ\text{C}$

### Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	100	$^\circ\text{C/W}$

**Electrical Characteristics at  $T_j=25^{\circ}\text{C}$  (unless otherwise specified)**
**Static Characteristics**

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-0.3	-0.75	-1.0	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{GS}=0V, V_{DS}=-16V, T_j=25^{\circ}\text{C}$	-	-	-1	$\mu A$
		$V_{GS}=0V, V_{DS}=-16V, T_j=125^{\circ}\text{C}$	-	-	-10	
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	$\pm 100$	nA
Drain to Source on Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-3A$	-	83	100	m $\Omega$
		$V_{GS}=-2.5V, I_D=-2.5A$	-	110	135	
Transconductance	$g_{fs}$	$V_{DS}=-5V, I_D=-3A$	-	5	-	S

**Dynamic Characteristics**

Input Capacitance	$C_{iss}$	$V_{GS}=0V, V_{DS}=-10V, f=1\text{MHz}$	-	382	-	pF
Output Capacitance	$C_{oss}$		-	70	-	
Reverse Transfer Capacitance	$C_{rss}$		-	60	-	
Total Gate Charge	$Q_g$	$V_{DD}=-10V, I_D=-3A, V_{GS}=-4.5V$	-	7.2	-	nC
Gate to Source Charge	$Q_{gs}$		-	1.2	-	
Gate to Drain (Miller) Charge	$Q_{gd}$		-	2.3	-	
Turn on Delay Time	$t_{d(on)}$	$V_{DD}=-10V, I_D=-1A, V_{GS}=-4.5V, R_G=6\Omega,$	-	10	-	ns
Rise time	$t_r$		-	20	-	
Turn off Delay Time	$t_{d(off)}$		-	15	-	
Fall Time	$t_f$		-	12	-	

**Reverse Diode Characteristics**

Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_F=-2A$	-		-1.2	V
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Fig 1. Typical Output Characteristics

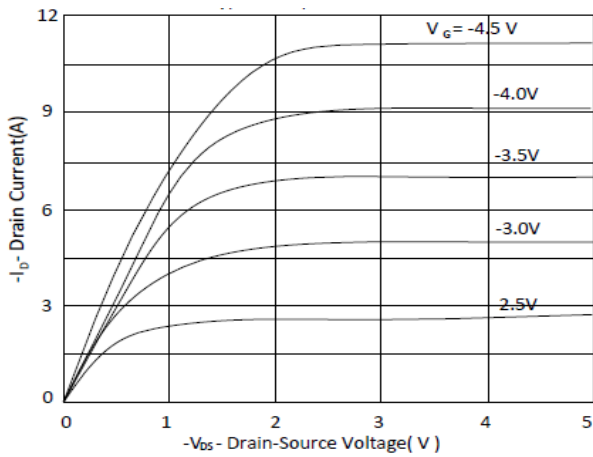


Figure 2. On-Resistance vs. Gate-Source Voltage

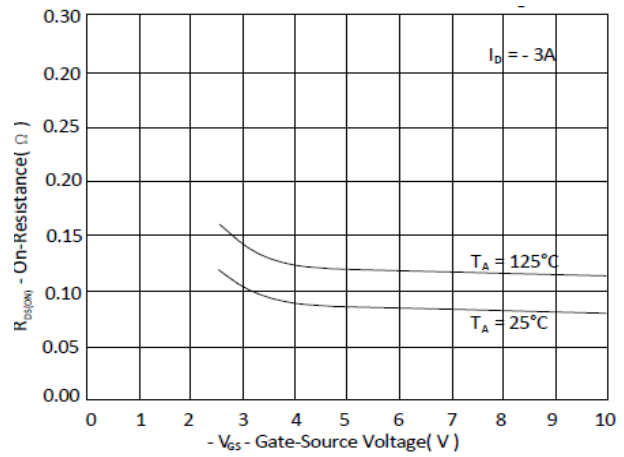


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

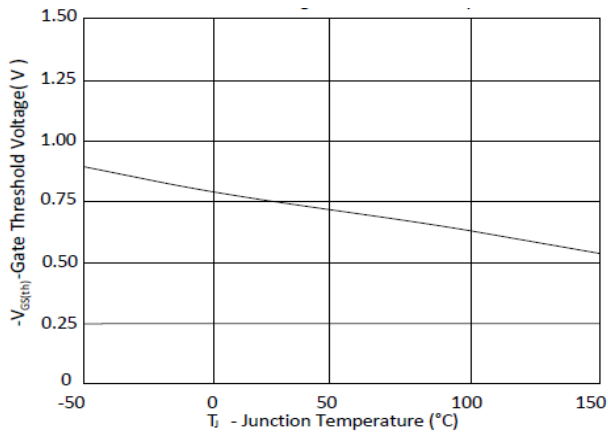


Figure 4. Normalized On-Resistance vs. Junction Temperature

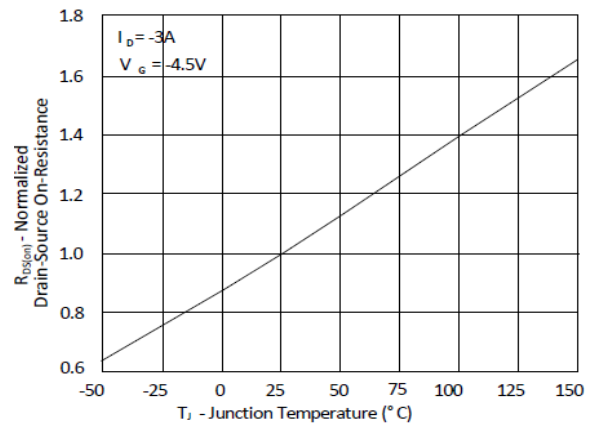
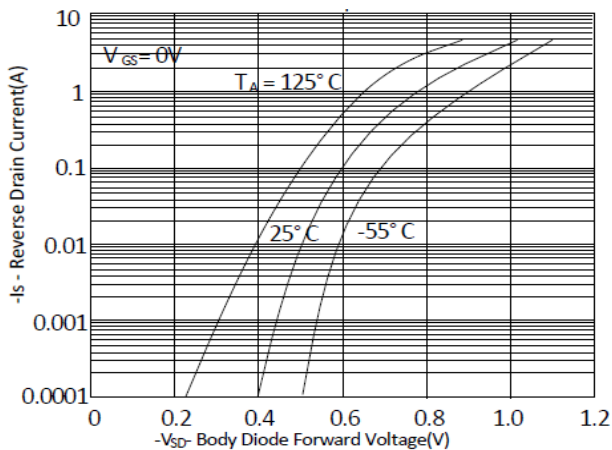
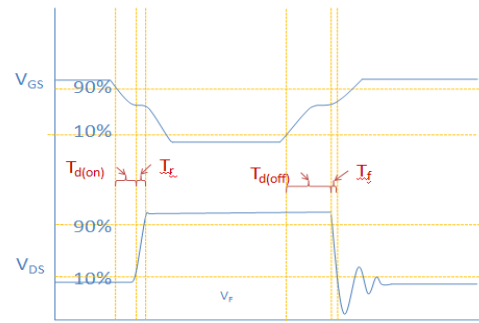
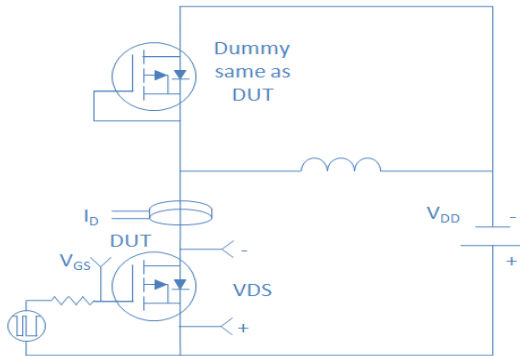


Figure 5. Typical Source-Drain Diode Forward Voltage

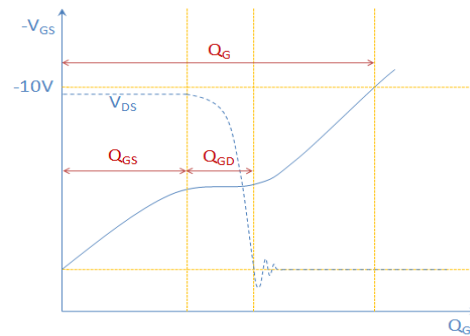
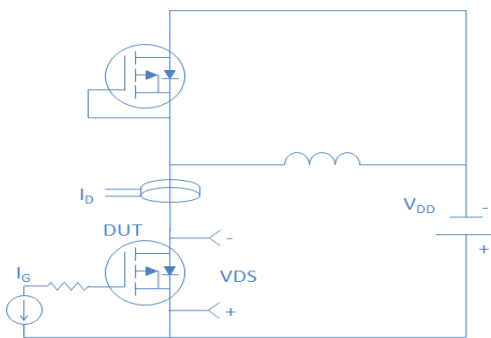




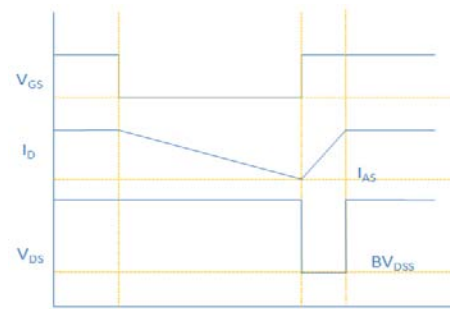
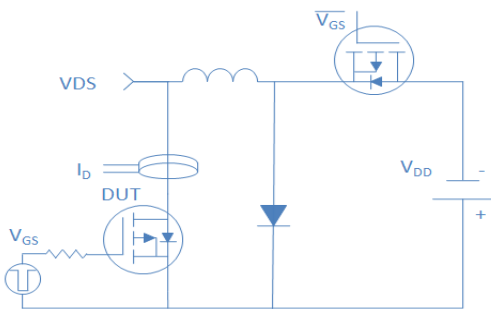
Inductive switching Test



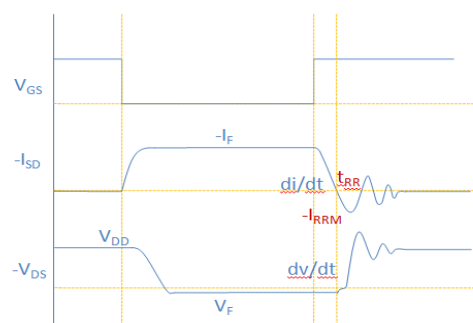
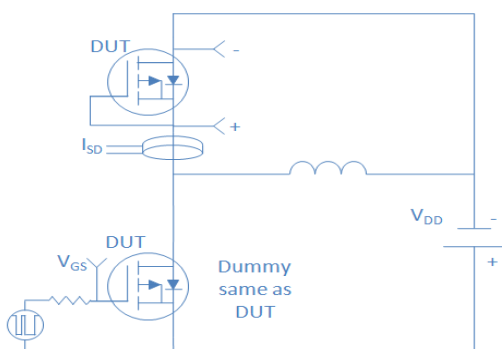
Gate Charge Test



Uclamped Inductive Switching (UIS) Test

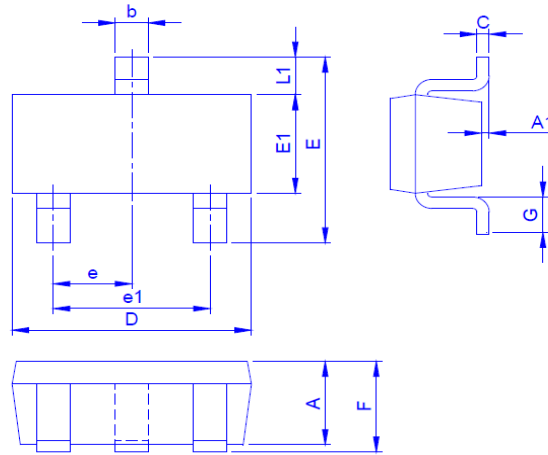


Diode Recovery Test



Package Outline

SOT-23, 3leads



Dimension in mm

Dimension	A	A1	A2	b	C	D	E	E1	e	e1	F	G	L1
Min.	0.7	0		0.35	0.1	2.8	2.6	1.5	0.9		0.8	0.3	0.55
Typ.						2.9	2.8	1.6	0.95	1.9			
Max.	1.12	0.1		0.5	0.2	3	3	1.7	1		1.2	0.6	0.65